



OPEN[®]
Compute Project

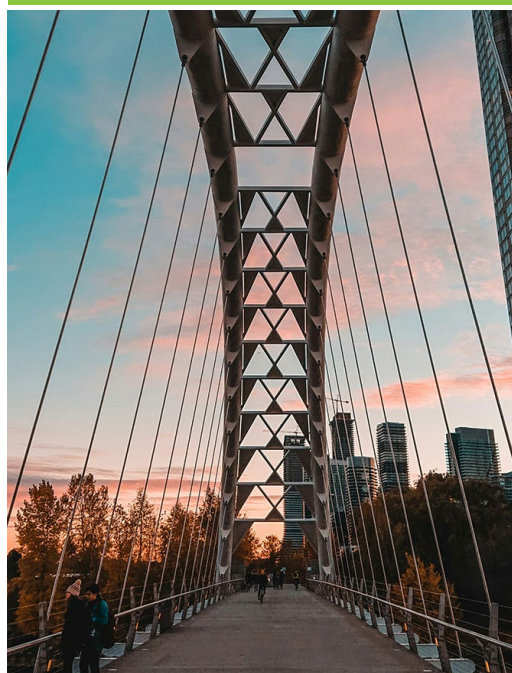
TORONTO



2027 OCP Canada Tech Day

SPONSOR PROSPECTUS

June 14 - 15, 2027 | Metro Toronto Convention Centre | Toronto



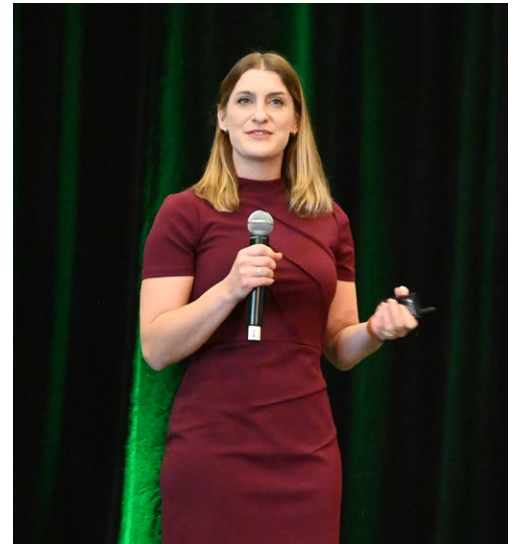
About the OCP Canada Tech Day

The OCP Canada Tech Day is a focused, engineering-driven gathering designed to accelerate open data center innovation across Canada's rapidly expanding cloud, AI, and digital infrastructure ecosystem. Bringing together hyperscalers, telecom operators, hardware manufacturers, solution providers, and academic researchers, the event advances the adoption of OCP-recognized technologies.

Building on the momentum of previous Canada Tech Day programs, the 2027 edition will convene technical leaders for a concentrated day of keynote updates, deep-dive breakout sessions, hands-on demonstrations, and community-driven collaboration.

2027 Program Themes

- AI Clusters
- AI Computing Continuum & Distributed Infrastructure
- Quantum Information Infrastructure Integration
- Cooling, Efficiency & Sustainable Data Center Design
- Hardware Reliability, Modularity & Open Rack Architectures
- Accelerated Compute
- Photonics & Optical Interconnects
- R&D and Emerging Technology Initiatives
- Community-Led Innovation & OCP Ecosystem Growth



Regional Importance

Canada has rapidly become a global center for AI research, advanced semiconductor workflows, and sustainable data center engineering. Toronto is home to many world leading research institutes, universities and a diverse ecosystem of data center related companies, and a rapidly expanding network of hardware and cloud organizations. Companies such as Bell Canada, Celestica, Ciena, Denvr Dataworks, IBM, Lightmatter, Meta, Microsoft, Nokia, Ranovus and hyperscale cloud teams have contributed to OCP-related discussions and deployments in the region.

Community Impact

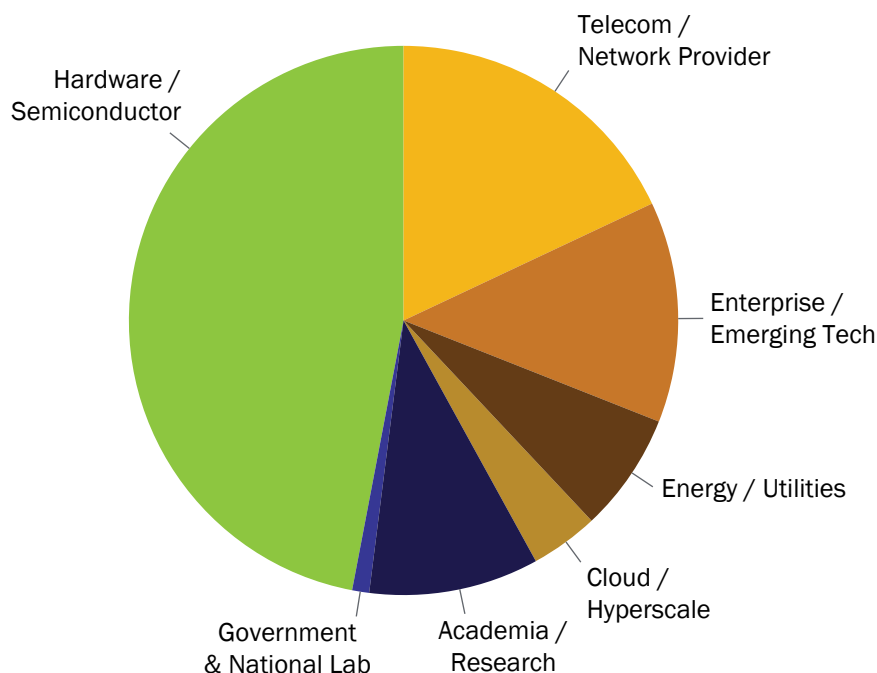
- The 2026 edition of the Canada Tech Day drew strong cross-industry engagement, reflecting the growing importance of open hardware in Canadian cloud and telecom ecosystems.
- Organizations represented in 2026 included major hyperscalers, national telecom providers, hardware manufacturers, data center operators, and leading academic research groups.
- The 2027 program introduces a Photonics and Optical Interconnect track to complement tracks including — including AI Clusters, AI Computing Continuum, Quantum Infrastructure Integration — underscoring Canada's leadership in next-generation compute and sustainability.

2026 OCP Canada Tech Day by the Numbers

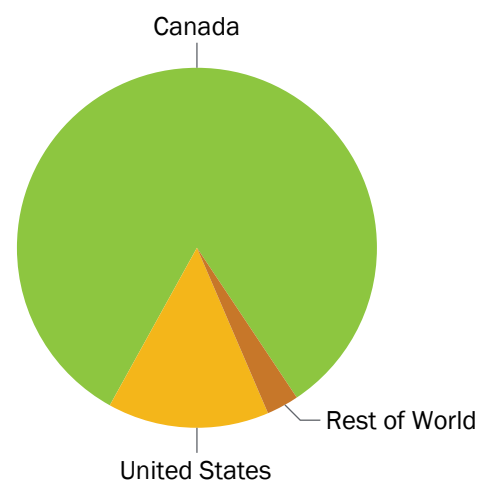


The OCP Canada Tech Day reflects a growing community of organizations driving open hardware adoption across the region. The data below highlights the diversity of participants and the industry segments represented at the 2026 event.

Attendees by Organization Type (2026 Data)



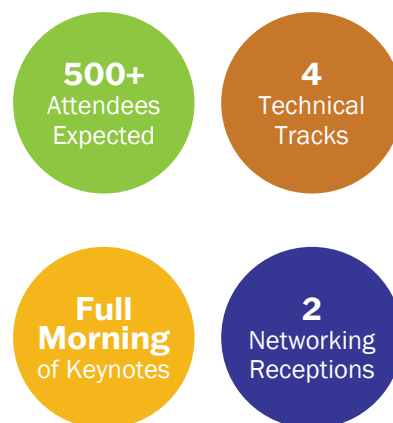
Attendees by Region (2026)



2026 Canada Tech Day Survey Highlights



Looking Ahead to 2027



Data based on 2026 OCP Canada Tech Day highlights; final 2027 attendee demographics will be published after the event.

The 2026 OCP Canada Tech Day brought together a diverse group of organizations from across the country's cloud, telecom, hardware, research, and emerging technology ecosystems. The following companies participated in last year's program.

Organizations Represented in 2026

1Finity	Conseil des technologies de l'information et des communications du Canada	Intelatech / Baknor	Qualcomm
2CRSI Canada	ContiTech Canada Inc.	intelatech.com	Quandela
5C Data Centers	CoolIT Systems	Investissement Québec	QuantHumAI Inc.
650 Group	CPC	International	Quantum Industry Canada
ABB	Credo Semiconductor	IQM Quantum Computers	QuebekIA
ACA TMetrix	Data Center Frontier	ISED-ISC	Radio-Canada
Actalent	Defence Research and Development Canada	Jabil	RAND Corporation
Actel Consulting	Dell Technologies	Keel Infrastructure Corp.	Ranovus
Advanced Test and Automation Inc.	Deloitte	Keysight Technologies	Renesas Electronics Canada Ltd.
AI.CONNECT Global	Delos Data	Ki3 Photonics Technologies	Rittal Limited Canada
Agentyo	Denvr Dataworks	Kontron Canada Inc.	Rivvor, Inc.
AIoT Canada	Eaton	Lanner Electronics	ROCKai
AMD	ECIN	Leaseweb Canada	Royal Canadian Navy
Ampere Computing	Ecole Polytechnique Montreal	Legrand	Samtec
Anyon Systems Inc.	Edgecom Energy	Lumentum	Schneider Electric
Apar Technologies Inc.	EfficiOS	M2M Tech	Siemens Canada
Apption	Electro Carbon	Marmon Data Center Solutions	Socomec
Aptiv	Elektro Automatik	Marvell	Soitec
Aquavap	Entelligent Inc.	Maya HTT	Spectrum Power Systems
Arm	Equal1	Microchip Technology	Staubli Corporation
Armstrong Fluid Technology	eStruxture Data Centers	Microsoft Canada	Stifel/Deepforge
ASIC FPGA Design Services	EXFO	Ministère de l'Économie, de l'Innovation et de l'Énergie	Supergate
AssistiQ	Extreme Networks	Montréal International	Syensqo
ATP Electronics	Fujitsu	Murata Electronics	Techno Contact Elite
AvidThink	Furukawa Electric Co., Ltd.	NetApp	TE Connectivity
Axonal Networks	GAL Power	Nokia	Teledyne LeCroy
Belden Canada ULC	Global Business Algorithms	Norda Technologies	Telehouse Canada
Bell Canada	GMA	Novabus Inc.	Tetrel Security
BellWether Electronics Corp	Grass Valley	Novapex	Tierx DCS
Betweenplays Media	Groupe ProModule	NovoPower International Inc.	TOTAL POWER LIMITED
Bitdeer	Hitachi High-Tech Canada	NowQuantum	TTP Plc
Bloomberg Intelligence	HPE	Numana	Umich
Boyd Corp.	Huawei Technologies Canada	NVIDIA	United Microelectronics Corporation
Bray Leino Canada	Hydro-Québec	Oetiker	Université de Sherbrooke
Calcul Québec	Hypertec	OPAL-RT Technologies Inc.	University Transportation Research Center
Calian	IBM Bromont	Open Quantum Design	Urbacon
Calogy Solutions	Infinium	ORCA Computing Ltd.	Vantage Data Centers
CBC/Radio-Canada	Information & Communications Technology Council	Perstorp	Vertiv Canada
CCI	Innovation Canada - ISED	Petro-Canada Lubricants	Victaulic
Celestica	Intel	PFX Group	Vidéotron
Cerabyte		PINQ²	Wesco
Cerio		Pomerleau	Wind River
Ciena		Powell Canada Inc.	Xanadu
Cisco		Power Bus Way (Legrand)	
Cohere Technologies		Prima Québec	

Schedule Overview

The 2027 OCP Canada Tech Day brings together keynotes, technical tracks, demonstrations, and networking across its main program day, with a brief reception held the evening before. The final session details will be announced as the event approaches.

Pre-Event Activities: Monday, 14 June 2027*	
Time	Event
Evening	Welcome Reception
	Table-Top Sponsor Setup

Day 1: Tuesday, 15 June 2027*	
Time	Event
Morning	Exhibits Open
	Continental Breakfast
	Registration
	Keynote Sessions
	Morning Coffee Break
Midday	Lunch Buffet
Afternoon	Breakout Sessions
	Afternoon Coffee Break
Evening	Networking Reception

**Schedule is subject to change.*



Metro Toronto Convention Centre, North Building

255 Front St W, Toronto, ON M5V 2W6, Canada



Sponsorship Packages



Showcase your company's presence at the 2027 OCP Canada Tech Day. These sponsorship packages offer brand visibility, onsite engagement, and access to key decision-makers, with flexible options to match your organization's goals.

Package	Co-Host Sponsor	Table-Top Sponsor	Event Sponsor
Price	\$7,500	\$6,000	\$2,500
Availability	Limited to 3	Limited to 12	Open availability
Complimentary Passes	3	2	1
Core Benefits	• Logo on OCP website and promotional communications • Mention in OCP Community Newsletter • Social media shoutouts		
Tier-Specific Benefits	• Listed as event Co-Hosts on event materials • Optional table-top display • Onsite signage placement	• Table-top display (hand-carried equipment only) • Pop-up floor banner permitted • Onsite signage placement	• Mention on keynote slides • Onsite signage placement

Support the growth of the OCP community while expanding your brand's visibility. Marketing Partner opportunities offer expanded visibility across digital promotions, event communications, and community outreach, extending your reach beyond the conference.

NEW!! Marketing Partner Opportunity	
Price	\$5,000
Availability	Limited to 5
Complimentary Passes	1
Benefits	• Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts (Linkedin & Facebook) • Logo on keynote welcome slides • Logo on event signage • Access to the Media & Analyst registration list • Promotional giveaway at registration** • Pop-up banner in prominent on-site location***

*OCP Tiered Membership discounts do not apply. All prices listed in USD.

**Opportunity to supply a promotional item approved by OCP at registration. The sponsor is responsible for the procurement and shipping costs; OCP will provide the storage and labor needed to distribute the items.

*** OCP to determine location of pop-up banner.

Reception Sponsorship Opportunities

Support the 2027 OCP Canada Tech Day through targeted, high-visibility sponsorship opportunities. These packages offer focused brand exposure across key touchpoints throughout the event.

Opening Reception Sponsor

Exclusive Sponsorship	\$10,000
Co-sponsorships	\$5,000 each
Passes Included	4
Sponsor Benefits:	• Logo prominently displayed during the opening reception • Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts (LinkedIn & Facebook) • Five-minute address to attendees during the reception • Onsite signage placement

Closing Reception Sponsor

Exclusive Sponsorship	\$10,000
Co-sponsorships	\$5,000 each
Passes Included	4
Sponsor Benefits:	• Logo prominently displayed during the evening reception • Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts (LinkedIn & Facebook) • Five-minute address to attendees during the reception • Onsite signage placement

**OCP Tiered Membership discounts do not apply.
All prices listed in USD.*



Additional Sponsorship Opportunities

Support the 2027 OCP Canada Tech Day through targeted, high-visibility sponsorship opportunities. These packages offer focused brand exposure across key touchpoints throughout the event.

Lanyard Sponsor — \$7,500		Passes Included	2
Sponsor Benefits:	• Logo on all attendee lanyards • Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts		
Coffee Sponsor — \$5,000		Passes Included	2
Sponsor Benefits:	• Logo displayed during morning and afternoon coffee breaks • Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts		
Breakfast Sponsor — \$5,000		Passes Included	2
Sponsor Benefits:	• Logo displayed during breakfast service • Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts		
Lunch Sponsor — \$5,000		Passes Included	2
Sponsor Benefits:	• Logo displayed during lunch service • Logo on OCP website and promotional communications • Mention in the OCP Community Newsletter • Social media shoutouts		

Create an exclusive experience that brings event attendees directly to your organization for a behind-the-scenes tour and meaningful engagement. Sponsor is responsible for all tour logistics.

Off-Site Tour — \$7,500		Passes Included	2
Sponsor Benefits:	• Recognition as the official sponsor of the off-site tour • Logo on OCP website and promotional communications • Access to the event attendee list for invitation curation • On-Site Recognition • Sponsor-Provided Giveaway		

**OCP Tiered Membership discounts do not apply.
All prices listed in USD.*



2027 OCP Canada Tech Day

Dates: June 14-15, 2027

Venue: Metro Toronto Convention Center – North Building (255 Front Street West)

This Agreement is made and entered into as of [date] _____ between the Open Compute Project (“OCP”) Foundation and:

Name of Organization _____

Address _____

City _____ State/Province/Region _____ Zip/Postal Code _____

Country _____ Phone _____

Sponsorship Logistics Contact _____ Email _____

Website _____

Sponsor Options for the 2027 OCP Canada Tech Day (the “Event”)*:

Event Sponsorships

(member discounts do not apply)

____ Co-Host Sponsor (max 3): \$7,500

____ Table Top Sponsor: \$6,000

____ Marketing Partner \$5,000

____ Event Sponsor: \$2,500

____ Lanyard Sponsor: \$7,500

____ Coffee Sponsor: \$5,000

____ Breakfast Sponsor: \$5,000

____ Lunch Sponsor: \$5,000

____ Opening Reception: \$10,000 exclusive

____ Opening Reception: \$5,000 co-sponsor

____ Closing Reception: \$10,000 exclusive

____ Closing Reception: \$5,000 co-sponsor

____ Off-site Tour: \$7,500

**All prices listed in USD. Please contact accounting@opencompute.org for billing questions.*

Total Amount: \$ _____

OCP Contact: Kali Burdette, Senior Director of Global Events, kali@opencompute.org

Payment Information: Acceptable forms of payment include ACH, wire transfers, credit cards and checks. If paying by check, please make checks payable to: Open Compute Project Foundation, 13785 Research Blvd, Suite 125, Austin TX 78750, USA

Terms and Conditions:

1. Payment must be in United States Dollars. All payments must be made to Open Compute Project Foundation and provided in cleared funds to the bank account provided on the invoice not later than net 30 days of the date of the invoice. All fees are exclusive of all applicable sales, use, value-added and similar taxes, which Sponsor shall pay in addition to the fees at the rate prevailing on the date of the invoice. Payment must be received prior to the event or the sponsorship will be considered invalid. Account must be current to participate.
2. If applicable, sponsor speakers are required to submit their presentation content for review by the Open Compute Foundation by the date indicated in the prospectus. Failure to submit your content for review by the foundation can result in the loss of your speaking opportunity.
3. Sponsor is responsible for meeting all deadlines for delivery of materials and artwork. Past due materials may be excluded from the conference program, signage, and other opportunities included in the sponsors contribution level.
4. Sponsor is responsible for any shipping and receiving costs the venue may charge for materials shipped directly to the venue.
5. Exhibit Locations. Booth/table location assignments will be selected by the sponsor company on a first-signed, first-served basis, and may be modified by the Foundation due to changes in event layout, venue or other factors.
6. Restrictions in Operations of Exhibits. The OCP Foundation and its representatives reserve the right to restrict or remove exhibits which, because of noise, method of operation, materials, or for any other reason, may become objectionable to the reasonable attendee or the venue. In the event of such restriction or eviction, the OCP Foundation is not liable for any refunds, rentals, or other exhibit expenses incurred by the Sponsor.
7. Care of Building. The Sponsor shall not injure or deface the walls or floors of the building and the tables, or damage the equipment. Sponsor assumes all liability costs for damage incurred.
8. Catastrophe. In the event that because of war, fire, strike, government regulation, natural disaster, pandemic, public catastrophe, act of God, or other cause, the conference or any part thereof is prevented from being held, or is canceled by the OCP Foundation, the OCP Foundation shall determine any refund to a Sponsor after deducting any expenses incurred by the OCP Foundation but in no case shall the amount of the refund to the Sponsor exceed the amount of the fee paid.
9. Cancellations made by the Sponsor 6 months or more prior to the event will not be subject to any fee. Cancellations made between 3 and 6 months prior to the event are liable for 50% of the sponsorship fee or the cost of equivalent services/equipment if the sponsorship is an in-kind or

barter arrangement. Cancellations made less than 3 months prior to the event are liable for the entire sponsorship fee or the cost of equivalent services/equipment. All cancellations must be made in writing to the OCP Foundation.

10. Trademarks. Each party retains all rights and ownership to its own trademarks and must obtain prior approval from the other party for any use of the other party's names or marks for the purpose of marketing, advertising and otherwise promoting participation in and/or sponsorship of (as described in this Agreement) the Event, which approval shall not be unreasonably withheld or delayed. Sponsor shall provide to OCP Foundation any artwork necessary for use of Sponsor's marks, name or logo. Sponsor agrees to abide by, and be bound by, the Open Compute Project Trademark Usage Guidelines, which are available at <https://bit.ly/2QwPmUN>, including as this may be updated by OCP Foundation from time to time. At the request of OCP Foundation, Sponsor will provide samples of its uses of OCP Foundation marks.

11. OCP Materials Release. If I am presenting at the OCP Canda Tech Day, I acknowledge that my Presentation and any ancillary materials I provide to OCP in connection with my Presentation, including without limitation any white paper, article, photograph, likeness, or professional biography (together, "Materials") are made available under the Creative Commons Attribution-ShareAlike 4.0 International License found at <https://creativecommons.org/licenses/by-sa/4.0/>, or any later version, and without limiting the foregoing, OCP may make the Materials available under such terms. OCP may exercise its rights hereunder in all forms and media, whether now known or hereafter developed, throughout the world in perpetuity, royalty-free. My authorization and acknowledgement above is irrevocable and extends to OCP and its agents, successors, and assigns. I hereby waive any right to inspect or approve the Recordings. I acknowledge that OCP is under no obligation to use the Recordings, or Materials if applicable, in any manner. I hereby represent that I have the authority to grant the rights and licenses herein. And if I am presenting at an OCP event, I further represent and warrant that the Materials do not and will not violate the rights of any third party, including without limitation rights in intellectual property. I also represent that, to the extent the Materials include materials owned or created by any third-party, I have obtained permission for its use consistent with the foregoing. I will provide OCP evidence of such permission upon OCP's request.

12. Miscellaneous. This Agreement shall be governed by the internal laws of the State of Delaware without regard to principles of conflicts of laws. Any disputes shall be heard exclusively in the state or federal courts located in Delaware, and both parties consent to the jurisdiction of such courts. Sponsor cannot assign any rights under this Agreement without the prior written consent of the OCP Foundation; any unauthorized assignment is null and void. This is the entire agreement of the parties and cannot be amended or changed except in a writing signed by both parties.

13. GDPR Policy. OCP will treat all information you provide in accordance with the OCP Privacy Policy posted at <http://www.opencompute.org/privacy/>. This includes cookies and any other information we may collect. By signing this contract, you acknowledge and accept OCP's Privacy Policy and give your consent to the transfer of your personal information to the United States, which may have less protections than your jurisdiction of residence.

14. BADGE SWAPPING. Badge swapping and/or trading is strictly prohibited at OCP events. Attendees must wear their badge at all times on the event premises. Any attendee caught without a badge, will be escorted to registration to show an ID and charged a reprint fee if the badge cannot be found. If caught wearing another attendee's badge or leaving the premises with multiple badges with the intent to distribute to other attendees, all badges will be confiscated and this person may be removed from the event. OCP reserves the right to deny attendance, sponsorship, and speaking opportunities to any individuals or organizations that do not abide by OCP event regulations.

In witness whereof, the parties have caused this Agreement to be executed by their duly authorized representatives.

Sponsor:

Signature: _____

Printed Name: _____

Title: _____

Date: _____

Open Compute Project Foundation:

Signature: _____

Printed Name: *Kali Burdette*

Title: *Senior Director of Global Events*

Date: _____